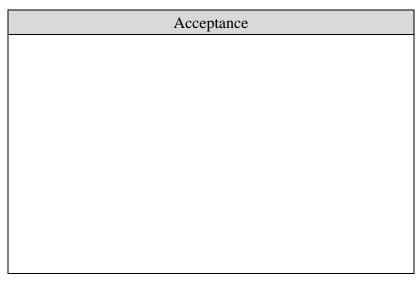
Messrs.						
Product Specification N	Model:	AWG-S240128AMBHSCWH-2	Rev. No.	Issued Date.	Page.	
	Wiodei.	AWG-5240128AMBHSCWH-2	A	2008/11/28	1/15	

LIQUID CRYSTAL DISPLAY MODULE MODEL: AWG-S240128AMBHSCWH-2 Customer's No.:



9 -1 Floor, No.192, Tahtung Road, Sec. 3, Hsi-Chih City, Taipei Hsien, Taiwan

1		
Approved and	Checked by	

Approved by	Check	ked by	Made by
權 叡	樺 叡		樺 叡
2008/11/28	2008/11/28		2008/11/28
闕敏樺	C.C		TOM

RECORD OF REVISION

Revision Date	Contents	Editor
2008/11/28	New Release	TOM

1 FEATURES

(1) Display format : 240×128 dot-matrix ; 1/128 duty.

(2) Construction: STN LCD, Bezel, Zebra, Heat Seal, CCFL Back-light and PCB.

(3) Display Type: STN. Negative, 6 o'clock view.

(4) Controller: SAP1024B.

(5) +5V signal power input. Built-in DC/DC converter for LCD driving.

(6) Extended temperature type.

2 MECHANICAL DATA

Parameter	Stand Value	Unit
Dot size	$0.47(W) \times 0.47(H)$	mm
Dot pitch	$0.50(W) \times 0.50(H)$	mm
Viewing area	132.0(W) × 76.0(H)	mm
Module size	$170.0(W) \times 103.2(H) \times 14.0$ max (T)	mm

3 ABSOLUTE MAXIMUM RATINGS

Parameter		Symbol	Min	Max	Unit
Logic Circuit	Logic Circuit Supply Voltage		-0.3	7.0	V
LCD Driving Voltage		VDD-VO	-0.3	26.0	V
Input Voltage		VI	-0.3	VDD+0.3	V
Extended temp. type	Operating Temp.	ТОР	-20	70	°C
	Storage Temp.	Tstg	-30	80	°C

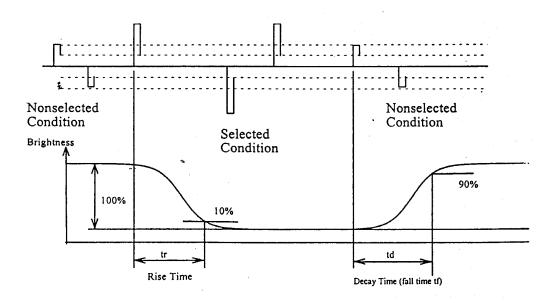
4 ELECTRO-OPTICAL CHARACTERISTICS

Parameter	Symbol	Condition	Min	Тур	Max	Unit	Note
		Electro	nic Chara	cteristics			
Logic Circuit Supply Voltage	VDD-VSS		4.5	5.0	5.5	V	
LCD Driving	VDD-VO	-20 °C		19.6		V	-20 ~ 70 °C for
Voltage		25 °C		18.5			Extended Temp. type
		70 °C		17.5			турс
Input Voltage	VIH		0.7 VDD		VDD	V	
	VIL		VSS		0.3 VDD	V	
Logic Supply Current	IDD	VDD = 5V		15	1	mA	
		Optica	al Charact	eristics -			
Contrast	CR	STN type		5			Note 1
Rise Time	tr	25°C		200	400	ms	Note 2
Fall Time	tf	25°C		150	300	ms	
Viewing Angle	θf	25°C &		40			Note 3
Range	θЬ	CR≥2		35		Deg.	
	θ1			35			
	θг			35			
Frame Frequency	fF	25°C		70		Hz	

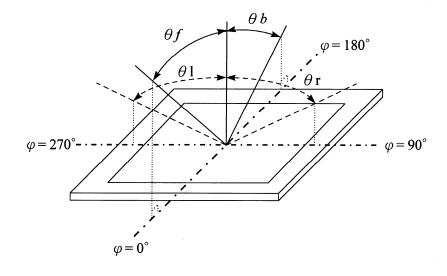
(NOTE 1) Contrast ratio:

CR = (Brightness in OFF state) / (Brightness in ON state)

(NOTE 2) Response time :



(NOTE 3) Viewing angle



5

4.1 C.C.F.L. BACK-LIGHT SPECIFICATION

(1) The half-brightness life of the back light shall be kept as specified under the following absolute maximum conditions:

Power Consumption 1.8 W

TA = 25°C, fL = 30KHz (with TDK CXA-L10L Inverter)

Tube current 3mArms min TA =

 25° C, fL = 30KHz 5mArms max.

(2) Electrical Characteristics

The following operating conditions are recommended for the back light unit.

Start Voltage 1000 Vrms min, at Ta=0 °C

Tube Voltage 360 Vrms typ, at Ta=25 °C

Tube Current 5 mArms typ, at Ta=25 °C

Drive Frequency 30 KHz typ, at Ta=25 °C

(3) Initial Optical Characteristics

The unit shall satisfy the following criteria at $25\pm2^{\circ}$ C ambient temperature, 30% - 85% relative humidity, no air flow and with applying rating input voltage and input current by using TDK CXA-L10L inverter.

Item	Min	Тур	Max	Unit	Note
LCD Module Brightness		140		Cd/m²	1
Brightness Uniformity	75%			%	
Chromaticity X	0.331	0.336	0.340		
Y	0.371	0.376	0.382		

NOTE 1: Ave. brightness should be measured 30 min. after initial power on.

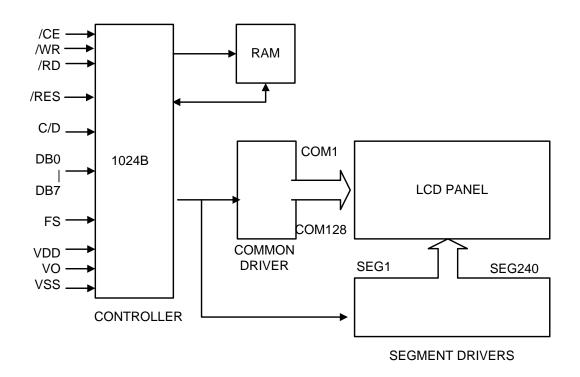
(4) Life

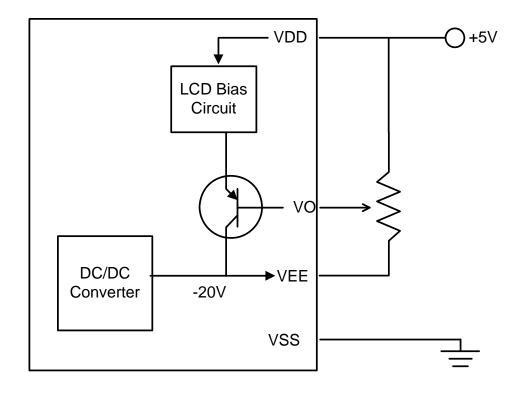
Half-Brightness Life of Unit

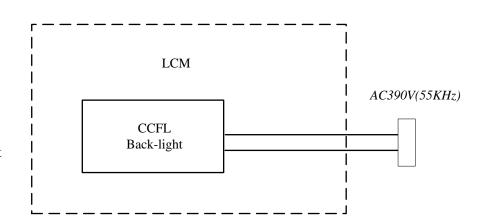
10,000 Hours min.

The definition of half-brightness life is either average brightness reach to 50% of initial average brightness or lamp stopping light emission.

5 BLOCK DIAGRAM & POWER SUPPLY







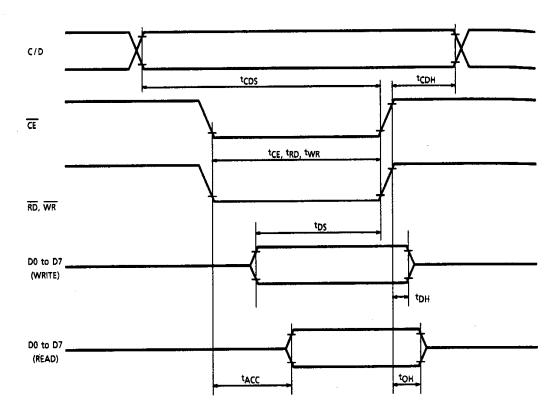
Using CCFL Back-light

6 PIN CONNECTIONS

Pin No.	Symbol	Function
1	FG	Frame Ground
2	VSS	Power Supply (0V)
3	VDD	Power Login Supply Voltage(+5V)
4	VO	LCD supply voltage (-)
5	/WR	Write data when WR = L
6	/RD	Read data when RD = L
7	/CE	Chip Enable
8	C/D	WR = L C/D = H : Command Write
9	VEE	-20V negative voltage power output for LCD driving
10	/RES	H Normal L Initialize T6963C
11 - 18	DB0 - DB7	Data Bus Line
19	FS	Pin for selection of font H Font 6x8 L Font 8x8
20	NC	No Connection

7 TIMING CHARACTERISTICS

Bus Timing



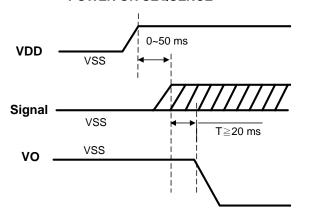
TEST CONDITIONS (Unless otherwise noted, $V_{DD} = 5.0V \pm 10\%$, $V_{SS} = 0V$, $T_{a} = -20$ to 75°C)

ITEM	SYMBOL	TEST CONDITIONS	MIN	MAX	UNIT
C/D Set-up Time	tCDS		100	_	ns
C/D Hold Time	tCDH	-	10		ns
CE, RD, WR Pulse Width	t _{CE} , t _{RD} , t _{WR}	_	80		ns
Data Set-up Time	tos		80		ns
Data Hold Time	t _{DH}		40	_	ns
Access Time	tACC	-	_	150	,ns
Output Hold Time	tон	_	10	50	ns

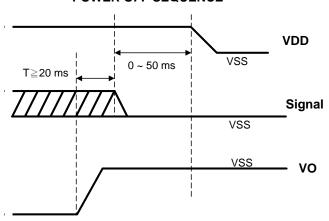
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7.1 Power ON/OFF Sequence

POWER ON SEQUENCE



POWER OFF SEQUENCE



8 QUALITY AND RELIABILITY

8.1 TEST CONDITIONS

Tests should be conducted under the following conditions:

Ambient temperature : 25 ± 5 °C

Humidity : $60 \pm 25\%$ RH.

8.2 SAMPLING PLAN

Sampling method shall be in accordance with MIL-STD-105E , level II, normal single sampling plan .

8.3 ACCEPTABLE QUALITY LEVEL

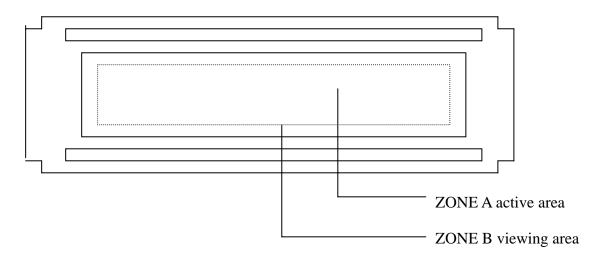
A major defect is defined as one that could cause failure to or materially reduce the usability of the unit for its intended purpose. A minor defect is one that does not materially reduce the usability of the unit for its intended purpose or is an infringement from established standards and has no significant bearing on its effective use or operation.

8.4 APPEARANCE

An appearance test should be conducted by human sight at approximately 30 cm distance from the LCD module under flourescent light. The inspection area of LCD panel shall be within the range of following limits.

8.5 INSPECTION QUALITY CRITERIA

Item	Description	of def		Class of Defects	Acceptable level	
Function	Short circuit of	r Pattern	cut		Major	0.65
Dimension	Deviation from	m drawi	ngs		Major	1.5
Black spots	Ave . dia . D	area A	A	area B	Minor	2.5
	D≤0.2			ard		
	0.2 <d≤0.3< td=""><td colspan="2"></td><td>4</td><td></td><td></td></d≤0.3<>			4		
	0.3 <d≤0.4< td=""><td>2</td><td></td><td>3</td><td></td><td></td></d≤0.4<>	2		3		
	0.4 <d< td=""><td>0</td><td></td><td>1</td><td></td><td></td></d<>	0		1		
Black lines	Width W, Length I	Ĺ	A	В	Minor	2.5
	W≤0.03		dis	regard		
	0.03 <w≤0.05< td=""><td>3</td><td>4</td><td></td><td></td></w≤0.05<>		3	4		
	0.05 <w≤0.07, l≤3<="" td=""><td>3.0</td><td>1</td><td>1</td><td></td><td></td></w≤0.07,>	3.0	1	1		
	See line	criteria		•		
Bubbles in	Average diameter D	$0.2 < \Gamma$	0 < 0.3	5 mm	Minor	2.5
polarizer	for $N = 4$, $D >$	0.5 for l	N = 1			
Color	Rainbow color o	r newto	n ring	•	Minor	2.5
uniformity						
Glass	Obvious visib	ole dama	ige.		Minor	2.5
Scratches						
Contrast	See no	See note 1			Minor	2.5
ratio						
Response	See note 2				Minor	2.5
time						
Viewing angle	See no	ote 3			Minor	2.5



8.6 RELIABILITY

	Test Conditions		
Test Item	Normal Temp. type	Note	
High Temperature Operation	50±3°C, t=96 hrs		
Low Temperature Operation	0±3°C, t=96 hrs		
High Temperature Storage	70±3°C, t=96 hrs	1,2	
Low Temperature Storage	-20±3°C , t=96 hrs	1,2	
Temperature Cycle	-20°C ~ 25°C ~ 70°C 30 m in. 5 min. 30 min. (1 cycle) Total 5 cycle	1,2	
Humidity Test	40 °C, Humidity 90%, 96 hrs	1,2	
Vibration Test (Packing)	Sweep frequency: 10 ~ 55 ~ 10 Hz/1min Amplitude: 0.75mm Test direction: X.Y.Z/3 axis Duration: 30min/each axis	2	

Note 1 : Condensation of water is not permitted on the module.

Note 2 : The module should be inspected after 1 hour storage in normal conditions (15-35 $^{\circ}$ C , 45-65 $^{\circ}$ RH).

Definitions of life end point :

- Current drain should be smaller than the specific value.
- Function of the module should be maintained.
- Appearance and display quality should not have degraded noticeably.
- Contrast ratio should be greater than 50% of the initial value.

9 HANDLING PRECAUTIONS

- (1) A LCD module is a fragile item and should not be subjected to strong mechanical shocks.
- (2) Avoid applying pressure to the module surface. This will distort the glass and cause a change in color.
- (3) Under no circumstances should the position of the bezel tabs or their shape be modified.
- (4) Do not modify the display PCB in either shape or positioning of components.
- (5) Do not modify or move location of the zebra or heat seal connectors.
- (6) The device should only be soldered to during interfacing. Modification to other areas of the board should not be carried out.
- (7) In the event of LCD breakage and resultant leakage of fluid do not inhale, ingest or make contact with the skin. If contact is made rinse immediately.
- (8) When cleaning the module use a soft damp cloth with a mild solvent, such as Isopropyl or Ethyl alcohol. The use of water, ketone or aromatic is not permitted.
- (9) Prior to initial power up input signals should not be applied.
- (10) Protect the module against static electricity and observe appropriate anti-static precautions.

